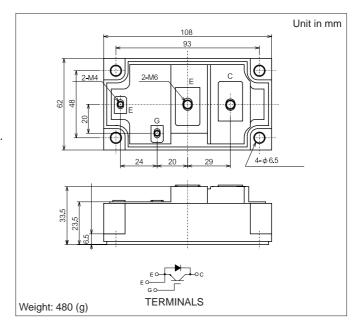
# MBN400GS12AW

Silicon N-channel IGBT

#### **OUTLINE DRAWING**

#### **FEATURES**

- \* High speed and low saturation voltage.
- \* low noise due to built-in free-wheeling diode ultra soft fast recovery diode(USFD).
- \* Isolated head sink (terminal to base).



ABSOLUTE MAXIMUM RATINGS (Tc=25°C)

Item		Symbol	Unit	MBN400GS12AW		
Collector Emitter Voltage		Vces	V	1,200		
Gate Emitter Voltage		$V_{GES}$	V	±20		
Collector Current	DC	Ic	Α	400		
	1ms	I <sub>Cp</sub>	A	800		
Forward Current	DC	lF	А	400 (1)		
	1ms	I <sub>FM</sub>	A	800		
Collector Power Dissipation		Pc	W	2,000		
Junction Temperature		Tj	°C	-40 ~ +150		
Storage Temperature	T <sub>stg</sub>	°C	-40 ~ +125			
Isolation Voltage	V <sub>ISO</sub>	V <sub>RMS</sub>	2,500(AC 1 minute)			
Screw Torque Ter	minals	-	N.m	1.37(14)/2.94(30) (2)		
Mo	unting	-	(kgf.cm)	2.94(30) (3)		

Notes:(1)RMS Current of Diode 120Arms max.

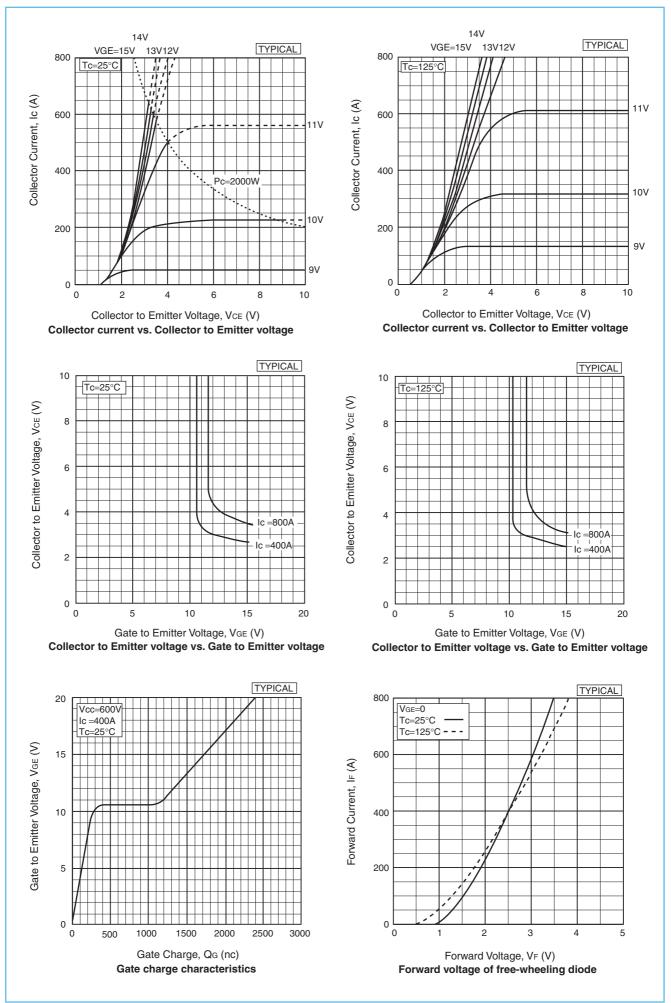
(2) Recommended Value 1.18/2.45N.m(12/25kgf.cm)

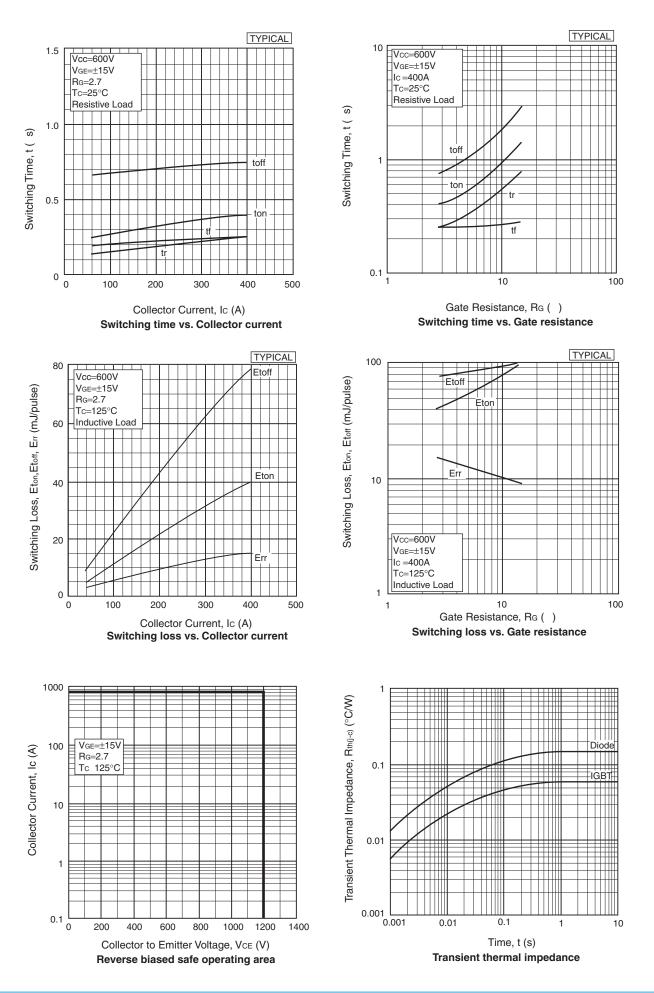
(3) Recommended Value 2.45 N.m (25 kgf.cm)

### CHARACTERISTICS (Tc=25°C)

Item		Symbol	Unit	Min.	Тур.	Max.	Test Conditions
Collector Emitter Cut-Off Current		I <sub>CES</sub>	mA	-	-	1.0	V <sub>CE</sub> =1,200V,V <sub>GE</sub> =0V
Gate Emitter Leakage Current		I <sub>GES</sub>	nA	-	-	±500	V <sub>GE</sub> =±20V,V <sub>CE</sub> =0V
Collector Emitter Saturation Voltage		V <sub>CE(sat)</sub>	V	-	2.7	3.4	I <sub>C</sub> =400A,V <sub>GE</sub> =15V
Gate Emitter Threshold Voltage		V <sub>GE(TO)</sub>	V	-	-	10	$V_{CE}=5V$ , $I_{C}=400mA$
Input Capacitance		Cies	pF	-	37,000	-	$V_{CE}=10V, V_{GE}=0V, f=1MHz$
Switching Times	Rise Time	tr		-	0.25	0.5	V <sub>CC</sub> =600V
	Turn On Time	ton	μS	-	0.4	0.7	$R_L=1.5\Omega$
	Fall Time	t <sub>f</sub>		-	0.25	0.35	$R_G=2.7\Omega$ (4)
	Turn Off Time	t <sub>off</sub>		-	0.75	1.1	V <sub>GE</sub> =±15V
Peak Forward Voltage Drop		V <sub>FM</sub>	V	-	2.5	3.5	I <sub>F</sub> =400A,V <sub>GE</sub> =0V
Reverse Recovery Time		trr	μS	-	-	0.4	I <sub>F</sub> =400A,V <sub>GE</sub> =-10V, di/dt=400A/μs
Thermal Impedance IGBT		Rth(j-c)	°C/W	-	-	0.06	Junction to case
	FWD	Rth(j-c)		-	-	0.14	

Notes:(4)  $R_G$  value is the test condition's value for decision of the switching times, not recommended value. Determine the suitable  $R_G$  value after the measurement of switching waveforms (overshoot voltage,etc.)with appliance mounted.





## HITACHI POWER SEMICONDUCTORS

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